

Product data sheet

1. General description

Planar passivated Silicon Controlled Rectifier with sensitive gate in a TO92 plastic package. This SCR is designed to be interfaced directly to microcontrollers, logic ICs and other low power gate trigger circuits.

2. Features and benefits

- High voltage capability
- · Planar passivated for voltage ruggedness and reliability
- Sensitive gate

3. Applications

- Ignition circuits
- Lighting ballasts
- Protection circuits
- Switched Mode Power Supplies

4. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|---------------------|--|--|-----------|-----|-----|-----|------|
| Absolute | maximum rating | · · · · · · · · · · · · · · · · · · · | · · · · · | | | | |
| V_{RRM} | repetitive peak reverse voltage | | | - | - | 600 | V |
| I _{T(AV)} | average on-state current | half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 1</u> | | - | - | 0.5 | A |
| I _{T(RMS)} | RMS on-state current | half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 2;</u> <u>Fig. 3</u> | | - | - | 0.8 | A |
| I _{TSM} | non-repetitive peak on- state current | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5 | | - | - | 8 | A |
| | | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms | | - | - | 9 | А |
| Tj | junction temperature | | | - | - | 125 | °C |
| Static cha | aracteristics | · · · · · | i | | | | |
| I _{GT} | gate trigger current | $V_{\rm D}$ = 12 V; I _T = 10 mA; T _j = 25 °C; <u>Fig. 7</u> | | - | 50 | 200 | μA |
| Dynamic | characteristics | · · · · · | · · · | | | | |
| dV _D /dt | rate of rise of off-state voltage | $V_{DM} = 402 \text{ V}; \text{T}_{\text{j}} = 125 \text{ °C}; \text{R}_{\text{GK}} = 1 \text{ k}\Omega;$ (V _{DM} = 67% of V _{DRM}); exponential waveform; <u>Fig. 12</u> | | 500 | 800 | - | V/µs |
| | | V_{DM} = 402 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit; Fig. 12 | | - | 25 | - | V/µs |

5. Pinning information

| Table 2. I | Pinning infor | mation | | |
|------------|---------------|-------------|--|----------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | А | anode | | |
| 2 | G | gate |] [| А Ң К |
| 3 | К | cathode | () () () 3 2 1 TO-92 (SOT54) | G sym037 |

6. Ordering information

| Table 3. Ordering info | ormation | | | | | |
|------------------------|-----------------|-----------------------|----------------|---------------------------|------------------|--------------------|
| Type number | Package Name | Orderable part number | Packing method | Small packing quantity | Package version | Package issue date |
| BT169G | TO92 | BT169GEP | Bulk | 1000 | SOT54 | 14-Nov-2013 |
| BT169G | TO92 | BT169G,126 | Reel | 2000 | SOT54 wide pitch | 14-Nov-2013 |
| BT169G | TO92 | BT169G,112 | Bulk | 1000 | SOT54 | 14-Nov-2013 |
| BT169G/DG | ТО92 | BT169G/DG,126 | Reel | 2000 | SOT54 wide pitch | 14-Nov-2013 |

7. Marking

| Table 4. Marking codes | |
|------------------------|---------------|
| Type number | Marking codes |
| BT169G | BT169G |

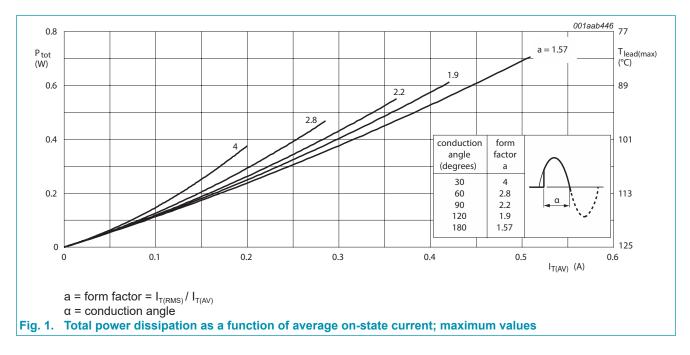
8. Limiting values

Table 5. Limiting values

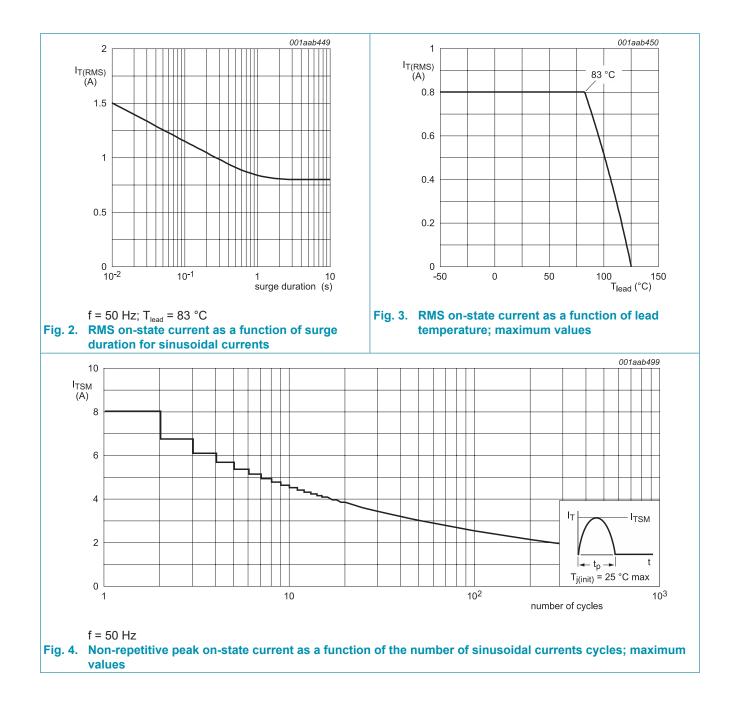
In accordance with the Absolute Maximum Rating System (IEC 60134).

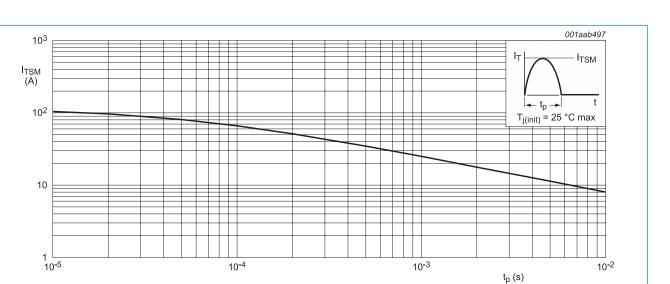
| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---------------------|--|--|-----|-----|------|------------------|
| V _{DRM} | repetitive peak off-state voltage | | | - | 600 | V |
| V _{RRM} | repetitive peak reverse voltage | | | - | 600 | V |
| I _{T(AV)} | average on-state current | half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 1</u> | | - | 0.5 | А |
| I _{T(RMS)} | RMS on-state current | half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 2; Fig. 3</u> | | - | 0.8 | А |
| I _{TSM} | non-repetitive peak on- state current | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5 | | - | 8 | A |
| | | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms | | - | 9 | А |
| l ² t | l ² t for fusing | t _p = 10 ms; SIN | | - | 0.32 | A ² s |
| dl _⊤ /dt | rate of rise of on-state current | $I_T = 2 \text{ A}; I_G = 10 \text{ mA}; \text{dI}_G/\text{dt} = 100 \text{ mA}/\mu\text{s}$ | | - | 50 | A/µs |
| I _{GM} | peak gate current | | | - | 1 | А |
| V_{RGM} | peak reverse gate voltage | | | - | 5 | V |
| P _{GM} | peak gate power | | | - | 2 | W |
| P _{G(AV)} | average gate power | over any 20 ms period | | - | 0.1 | W |
| T _{stg} | storage temperature | | | -40 | 150 | °C |
| Tj | junction temperature | | [1] | - | 125 | °C |

[1] Operation above 110°C may require the use of a gate to cathode resistor of $1k\Omega$ or less.



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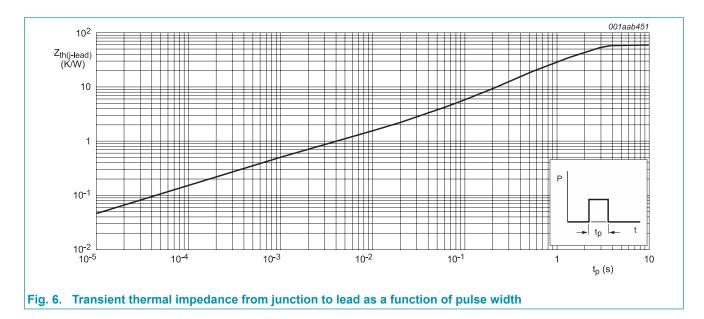


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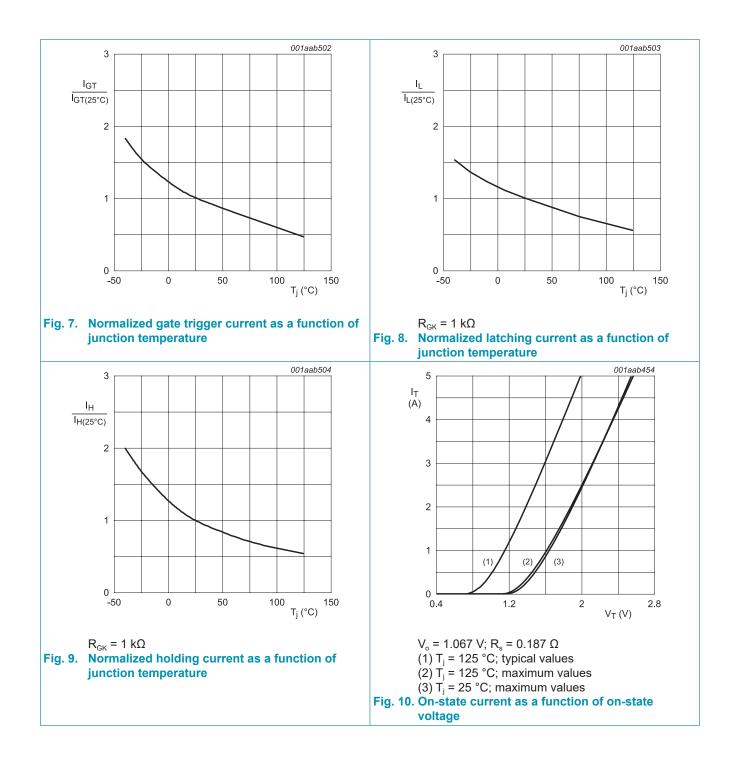
9. Thermal characteristics

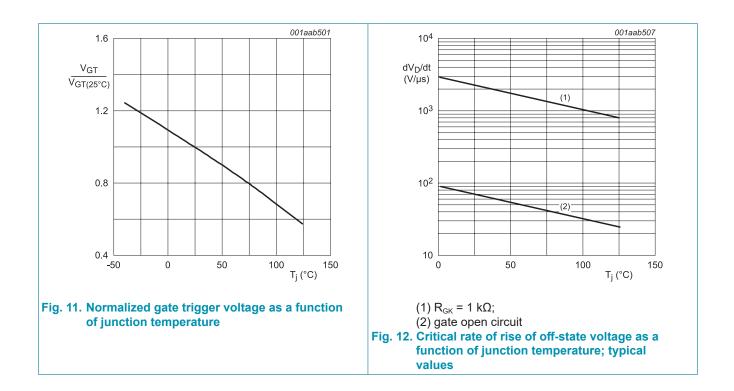
| able 6. Thermal characteristics | | | | | | | |
|---------------------------------|--|--|--|-----|-----|-----|------|
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
| $R_{\text{th(j-lead)}}$ | thermal resistance from junction to lead | <u>Fig. 6</u> | | - | - | 60 | K/W |
| $R_{\text{th(j-a)}}$ | thermal resistance from junction to ambient free air | printed circuit board mounted: lead length = 4 mm | | - | 150 | - | K/W |



10. Characteristics

| Table 7. Cl | naracteristics | | | | | |
|---------------------|-----------------------------------|---|-----|------|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| Static cha | racteristics | | | | | |
| I _{GT} | gate trigger current | V _D = 12 V; I _T = 10 mA; T _j = 25 °C; <u>Fig. 7</u> | - | 50 | 200 | μA |
| I _L | latching current | V _D = 12 V; I _G = 0.5 mA; T _j = 25 °C; <u>Fig. 8</u> | - | 2 | 6 | mA |
| I _H | holding current | V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u> | - | 2 | 5 | mA |
| V _T | on-state voltage | I _τ = 1.2 A; T _j = 25 °C; <u>Fig. 10</u> | - | 1.25 | 1.7 | V |
| V _{GT} | gate trigger voltage | $V_{D} = 12 \text{ V}; \text{ I}_{T} = 10 \text{ mA}; \text{ T}_{j} = 25 \text{ °C};$ Fig. 11 | - | 0.5 | 0.8 | V |
| | | $V_{\rm D}$ = 600 V; $I_{\rm T}$ = 10 mA; $T_{\rm j}$ = 125 °C | 0.2 | 0.3 | - | V |
| I _D | off-state current | $V_{D} = 600 \text{ V}; \text{ R}_{GK(ext)} = 1 \text{ k}\Omega; \text{ T}_{j} = 125 \text{ °C}$ | - | 0.05 | 0.1 | mA |
| I _R | reverse current | V_{R} = 600 V; T _j = 125 °C; R _{GK(ext)} = 1 kΩ | - | 0.05 | 0.1 | mA |
| Dynamic | characteristics | | | | | |
| dV _D /dt | rate of rise of off-state voltage | V_{DM} = 402 V; T _j = 125 °C; R _{GK} = 1 kΩ; (V_{DM} = 67% of V_{DRM}); exponential waveform; Fig. 12 | 500 | 800 | - | V/µs |
| | | V_{DM} = 402 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit; Fig. 12 | - | 25 | - | V/µs |
| t _{gt} | gate-controlled turn-on time | I_{TM} = 2 A; V _D = 600 V; I _G = 10 mA; dI _G / dt = 0.1 A/µs; T _j = 25 °C | - | 2 | - | μs |
| t _q | commutated turn-off time | | - | 100 | - | μs |

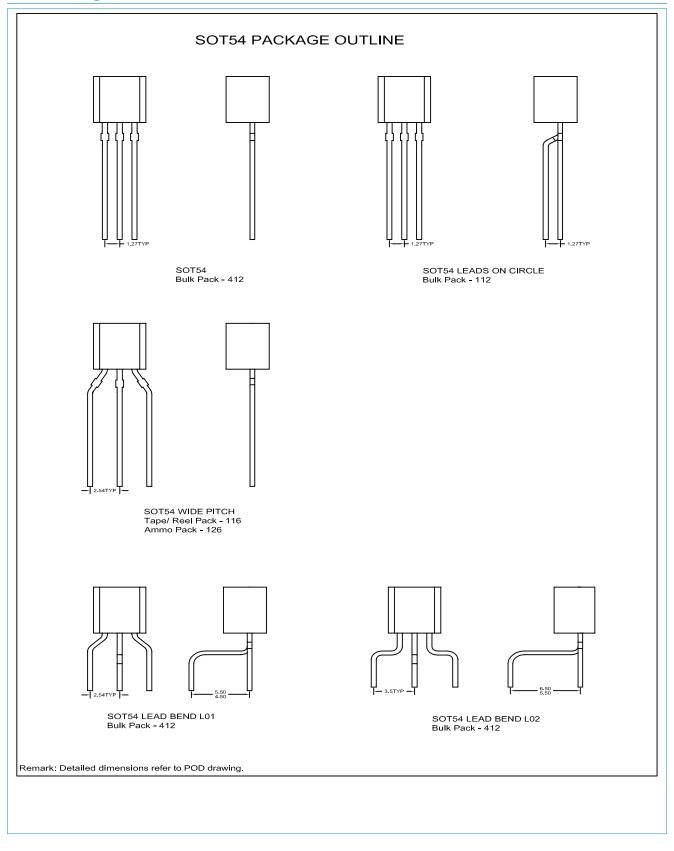


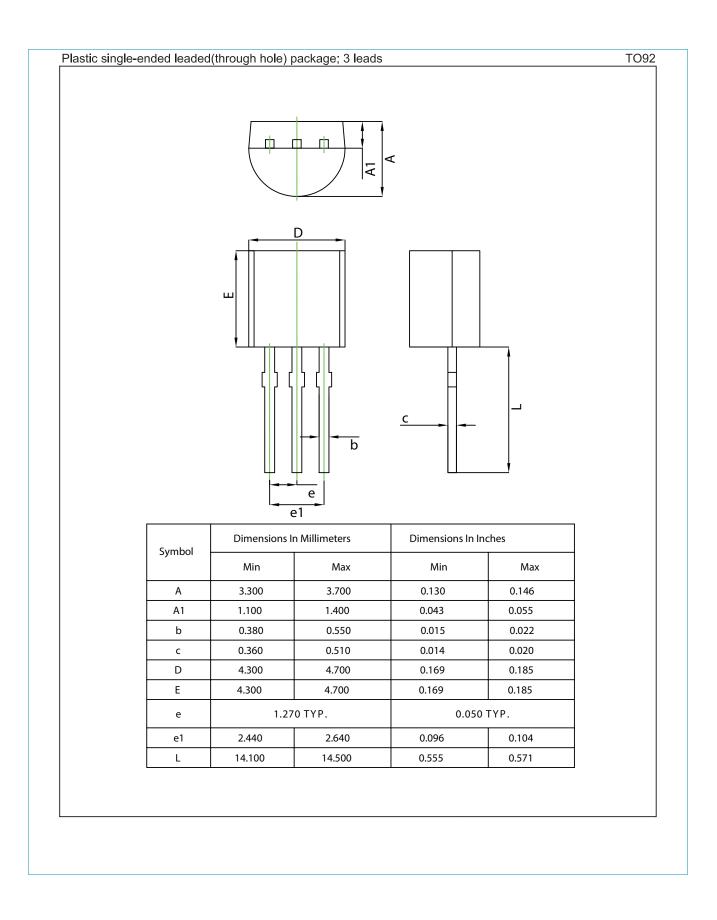


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11. Package outline





12. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
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